Application No.: NEW Docket No.: 4670-0113PUS1

AMENDMENTS TO THE CLAIMS

Claims 1-5 (canceled)

6. (new) A copolymer latex for use in dip molding, which satisfies the following

conditions:

(1) the copolymer is produced by copolymerization of 100 parts by weight of a monomer

mixture (A) comprising 45 to 85 parts by weight of a conjugated diene monomer, 10 to 40 parts

by weight of an ethylenic unsaturated nitrile monomer, 5 to 15 parts by weight of an ethylenic

unsaturated acid monomer, and 0 to 20 parts by weight of any other ethylenic unsaturated

monomer copolymerizable therewith;

(2) the content of methyl ethyl ketone-insoluble components in the copolymer is from

60% to 95% by weight; and

(3) the copolymer is produced by the following processes of:

(I) initiating a copolymerization reaction using a monomer mixture (a) that comprises at

least 80% by weight of the total amount of the conjugated diene monomer, 50 to 90% by weight

of the total amount of the ethylenic unsaturated nitrile monomer, 40 to 90% by weight of the

total amount of the ethylenic unsaturated acid monomer, and at least 80% by weight of the total

amount of the other ethylenic unsaturated monomer with respect to the respective components of

the monomer mixture (A);

(II) adding the remainder of the ethylenic unsaturated nitrile monomer and the remainder

of the ethylenic unsaturated acid monomer when the degree of polymerization conversion of the

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monomer mixture (a) is in the range from 5% to 95% by weight, wherein the remainders are a part of the monomer mixture (A) but not included in the monomer mixture (a); and

(III) also performing and completing addition of the remainder of the conjugated diene monomer and the remainder of the other ethylenic unsaturated monomer copolymerizable therewith by the time that the polymerization reaction is stopped.

7. (new) The copolymer latex for use in dip molding according to claim 6, wherein the remainder of the ethylenic unsaturated nitrile monomer is added to the polymerization reaction system when the degree of polymerization conversion of the ethylenic unsaturated nitrile monomer in the polymerization reaction system is in the range from 40% to 95% by weight.

- 8. (new) The copolymer latex for use in dip molding according to claim 6, wherein the remainder of the ethylenic unsaturated acid monomer is added to the polymerization reaction system when the degree of polymerization conversion of the total of the monomers in the polymerization reaction system is in the range from 20% to 80% by weight.
- 9. (new) The copolymer latex for use in dip molding according to claim 7, wherein the remainder of the ethylenic unsaturated acid monomer is added to the polymerization reaction system when the degree of polymerization conversion of the total of the monomers in the polymerization reaction system is in the range from 20% to 80% by weight.

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10. (new) A composition for use in dip molding, comprising the copolymer latex for use in dip molding according to claim 6, a vulcanizing agent and a vulcanization accelerator.

11. (new) A dip-molded product, which is produced by dip molding of the composition according to claim 10.

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